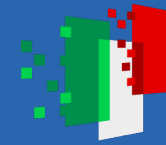




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dell'Università  
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Italiadomani  
PIANO NAZIONALE  
DI RIPRESA E RESILIENZA

INFN  
Istituto Nazionale di Fisica Nucleare

# Coating Thermal Noise

Diana Lumaca

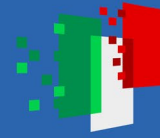
INFN – Sezione di Roma  
Tor Vergata





## Outline

- Coating thermal noise and sensitivity curve in future upgrade
- Mirror: state of the art
- Optical properties and characterization
- Mechanical properties and characterization
- Insight on metrology issues
- Research on new amorphous materials
- Origin of absorption and multi-technique investigation
- Crystalline coatings



## Coating Thermal Noise

- Coating thermal noise (CTN) limits the detection in the middle frequency bandwidth
- The key parameters are:

**TEMPERATURE on MIRROR**

**COATING MECHANICAL LOSS (depends on material properties)**

**COATING THICKNESS (depends on reflectivity and refractive indices)**

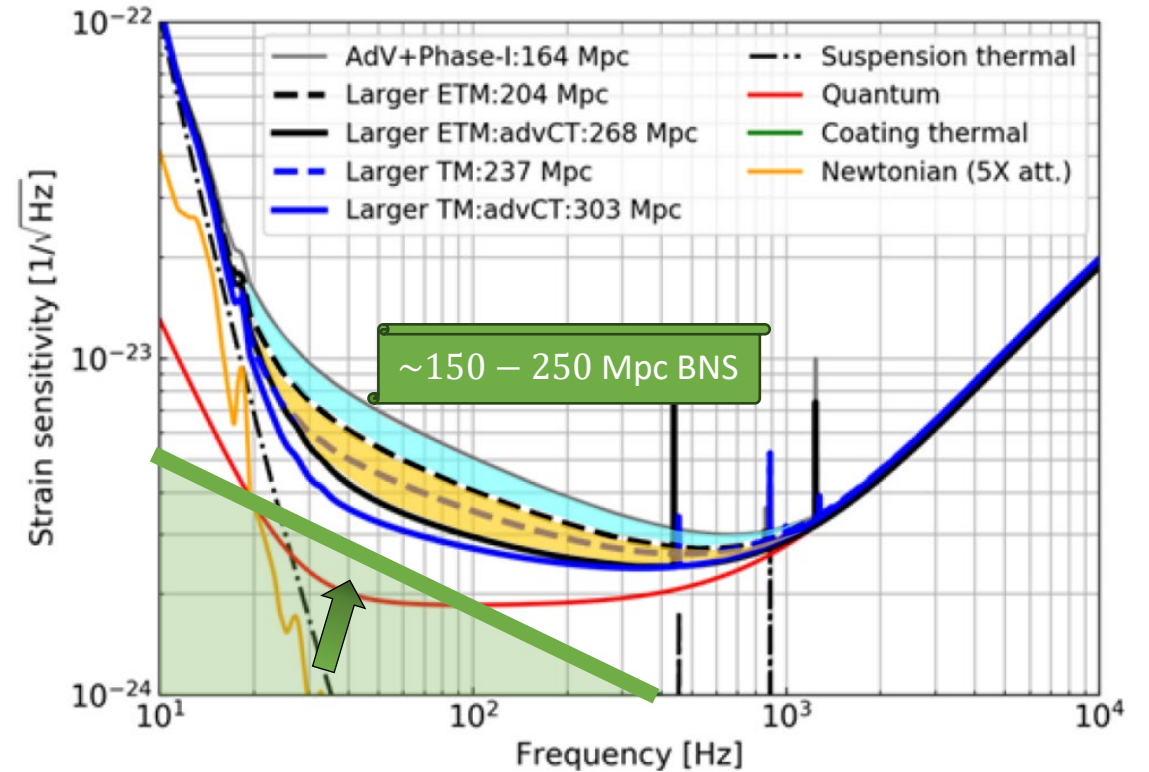
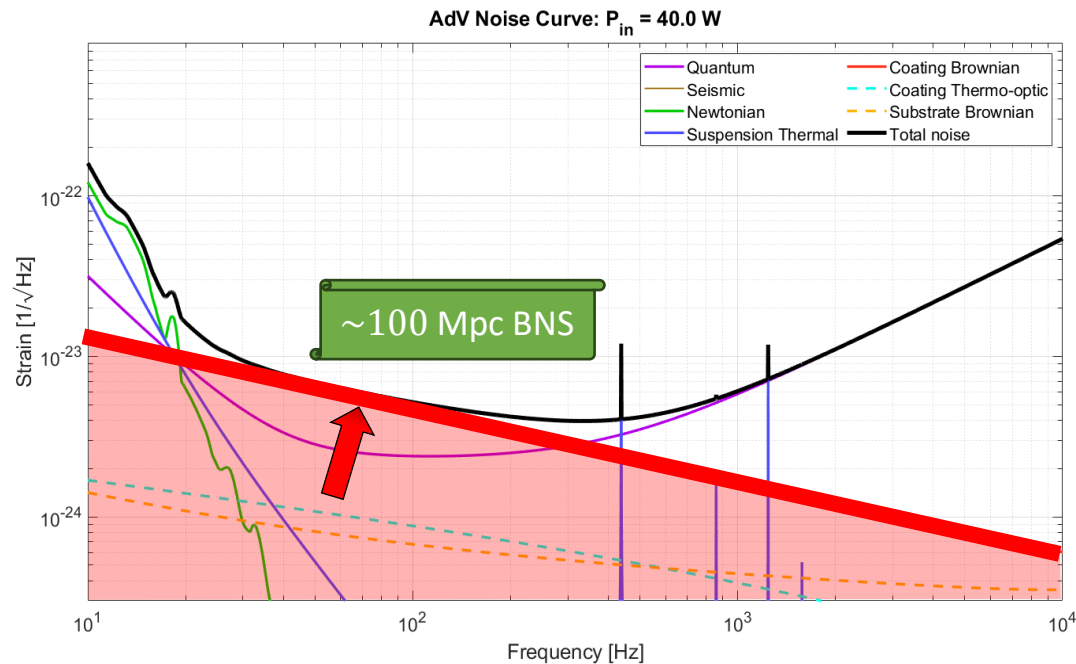
**BEAM-SIZE on MIRROR**

**ARM LENGTH**

$$\text{CTN}(f) \propto \sqrt{\frac{T}{f} \frac{1}{w_b^2} \phi t_{coat} L}$$



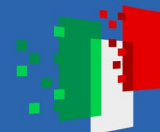
# Coating Thermal Noise in Advanced Virgo plus (AdV+)



Post O4 / O5 preparation upgrades:

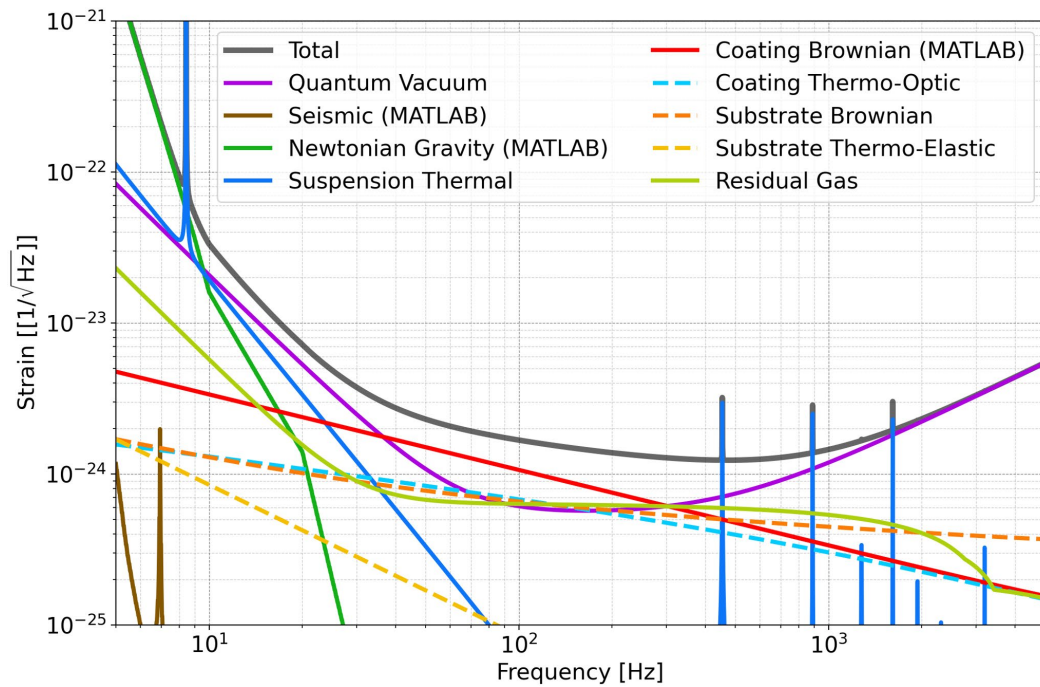
- Reduction of coating loss angle (foreseen a factor 3)
- Beam size increase on ETM (from 58 mm to 96 mm / ETM mass from 42 kg to 105 kg)



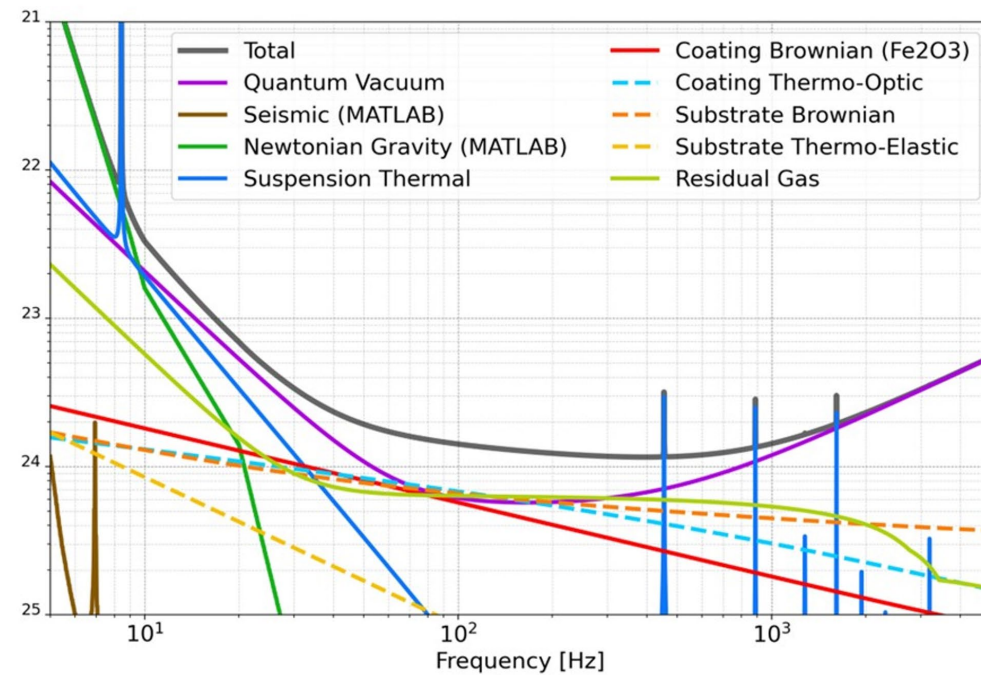


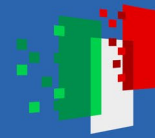
# Coating Thermal Noise in Virgo\_nEXT (PO5)

Virgo\_nEXT (amorphous coating), BNS = 440 Mpc, BBH = 3.0 Gpc



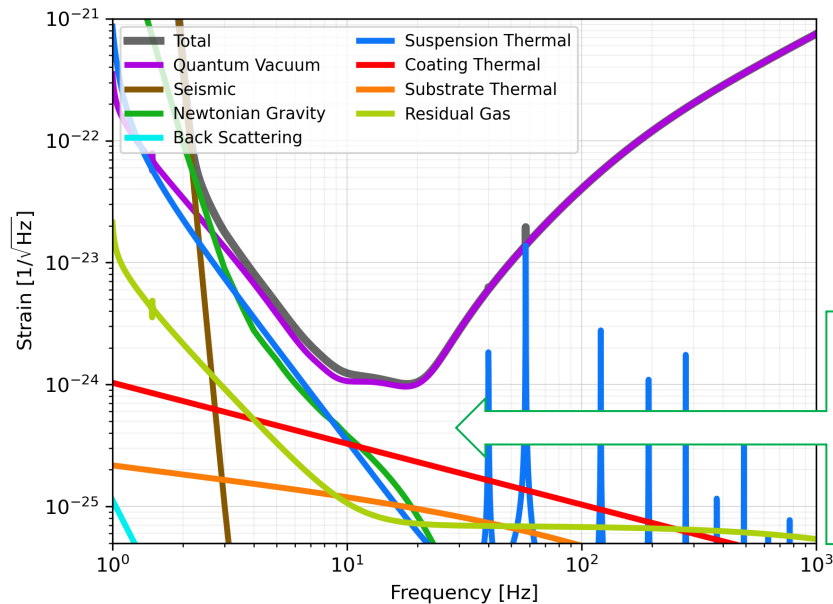
Crystalline Coatings BNS = 500.3 Mpc, BBH = 3.3 Gpc





# Coating Thermal Noise in Einstein Telescope

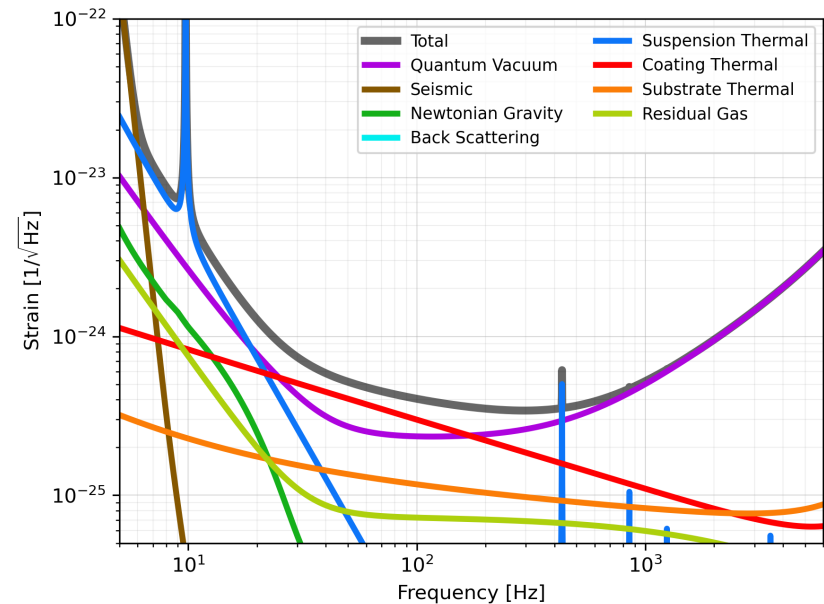
### Sensitivity curve LF-ET



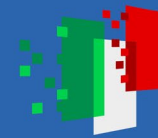
Cooling at low temperature (10K 20K or 120 K?) means reduce thermal noise at its origin.

Different laser wavelength, different **materials (substrates and coatings)**, take **absorption** under control to ensure cryogenics operation

### Sensitivity curve HF-ET



Same wavelength, substrate material and temperature as LIGO and Virgo detectors. New coating materials to **tolerate high laser power**



## Substrate material: Silica as a key material

**Fused silica** is a type of glass containing primarily silica in **amorphous** (non-crystalline, short-range order) form. The main distinguishing characteristic is its **purity** but other spectacular properties are accomplished:

### ➤ Optical

**optical transmission** is enormous

*"A 10 m thick quartz glass disk does not affect sight at all. The view is not different than looking through a normal window glass."*

### ➤ Mechanical

very low losses at room temperature, **bulk loss angle** is  $f \approx 10^{-9}$   
(steel has  $f \approx 10^{-4}$ )

### ➤ Thermal

**low thermal expansion coefficient** of approximately  $0,5 \cdot 10^{-6} \text{ K}^{-1}$ , compared to stainless steel, is 30 times lower during heating.



**enormous thermal shock resistance.**

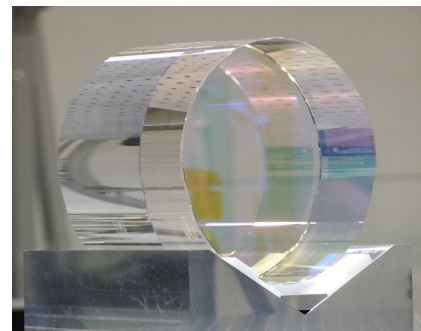
The quartz glass **withstands high temperature** and **exposure to cold water** without any damage.



## Substrate material: ET core optics

### ET-HF:

- **Silica SiO<sub>2</sub>**
- ✓ low thermoelastic effect
- ✓ low optical absorption
- ✓ low mechanical losses.
- ✓ properties are well-known



### ET-LF:

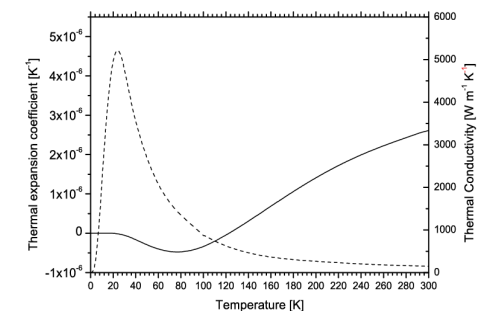
- **Sapphire (LF-ET)**
- ✓ High Young's modulus
- ✓ Transparent for 1064 nm, low mechanical loss at low temperature
- ➔ **birefringence, absorption and scattering** in dependence of manufacturers (axis orientation)



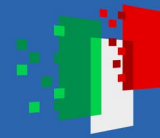
### ET-LF:

#### ➤ Silicon (LF-ET)

- ✓ low mechanical loss at cryogenic temperatures, thermal expansion coefficient at 123 K and 18 K (suppression of thermoelastic of substrate and thermal expansion effects)
- ➔ **change of the wavelength** 1550 nm or 2000 nm (suitable also with aSi as coating material)
- ➔ large size and low optical absorption







## Mirror Coatings basics

Enabling technology for GW detectors:

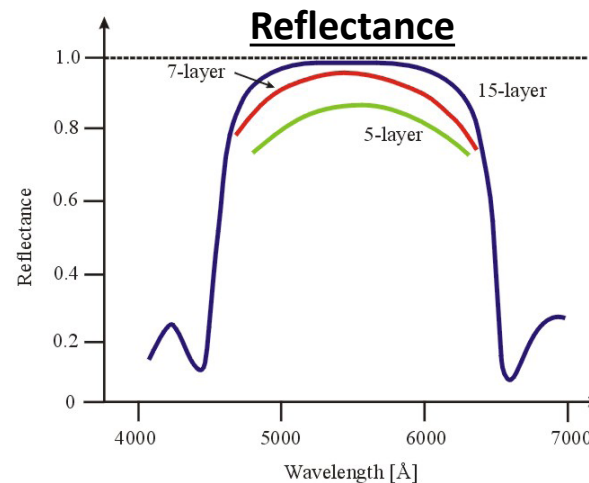
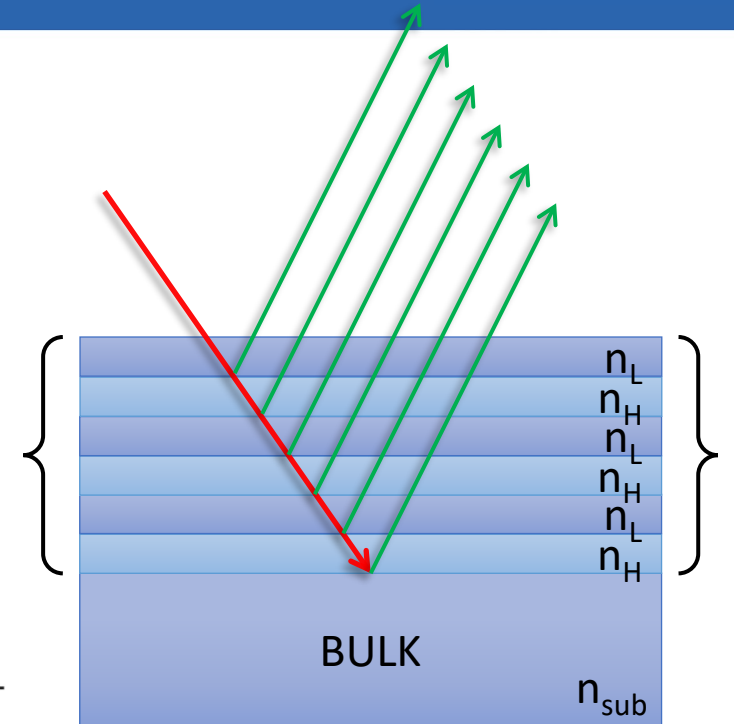
- dielectric mirrors = bulk + reflective multilayer coatings

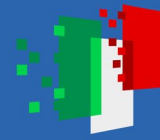
### Bragg reflectors

- It is a structure formed by **multiple layers** of alternating materials with periodic variation of refractive index
- In GW mirrors is a substrate + a stack of alternate layers of **high- and low-refractive index materials** ( $n_H$  and  $n_L$ )
- **Accurate choice of thickness**  $\cong \lambda/4$ 
  - Constructive interference
  - High-quality reflector

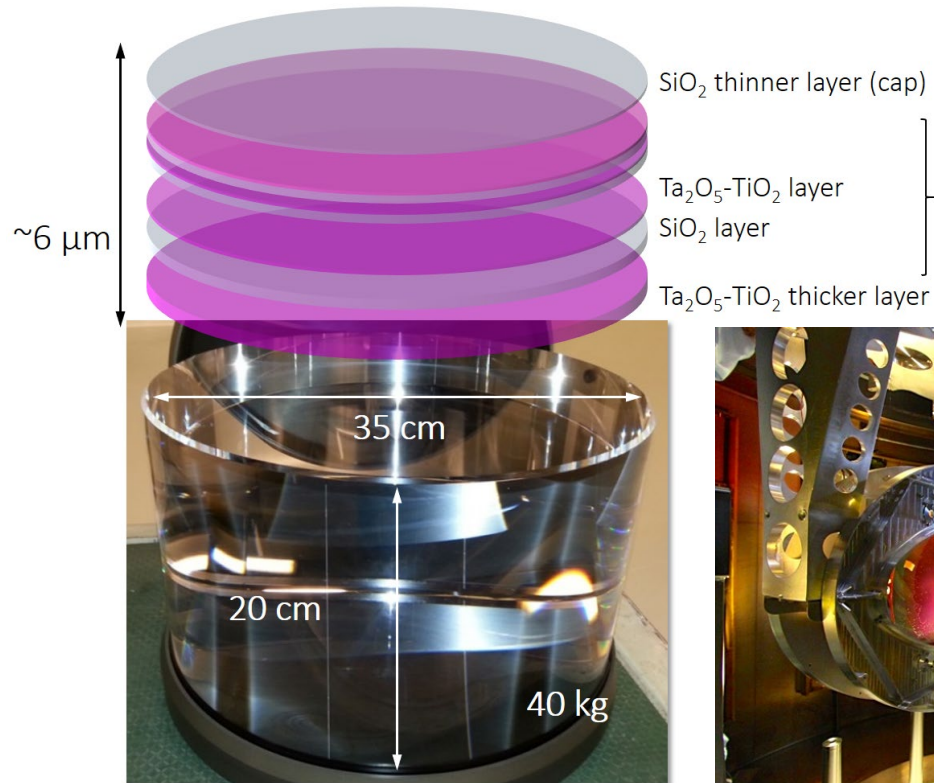
$$R = |r^2| = \frac{1 - n_{sub} \left(\frac{n_L}{n_H}\right)^{2N}}{1 + n_{sub} \left(\frac{n_L}{n_H}\right)^{2N}}$$

N doublets



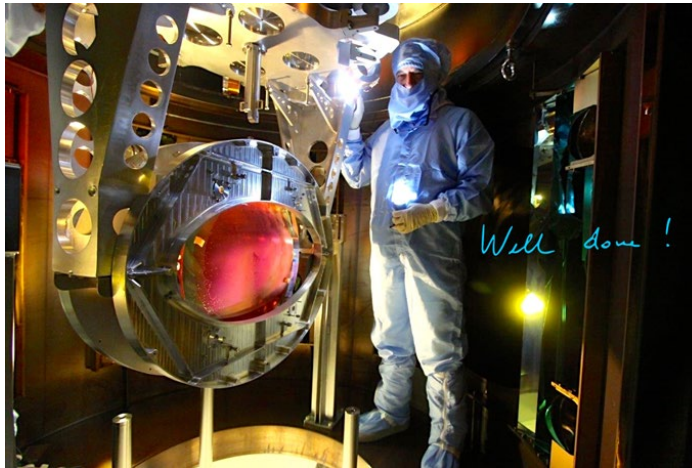


# State of the Art (Virgo/LIGO)

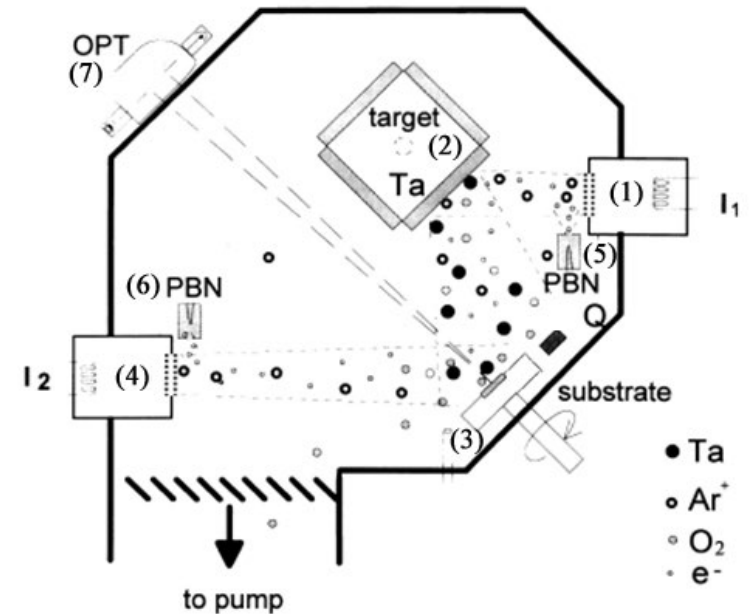


Silica SiO<sub>2</sub> n=1.45

Tantala TiO<sub>2</sub>:Ta<sub>2</sub>O<sub>5</sub> n=2.09



*Ion Beam Sputtering (IBS) deposition at Laboratoire de Materiaux Avances, in Lyon.*





## Mirror Coatings basics

### Required properties:

- **Low scattering** (from e.g. defects or micro-roughness or micro-crystals)
  - To avoid *diffused light* in the ITF
  - Only purely amorphous or single-crystalline materials suitable
- **Low optical absorption:** below 1 ppm ( $10^{-6}$ )
  - To avoid *thermal effects* in room temperature detectors
  - To avoid *heating* in cryogenic detectors

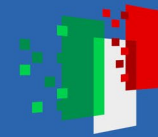
- **Low coating thermal noise (CTN):**
  - Linked to *mechanical dissipation*
  - Material research



**OPTICAL PROPERTIES**



**MECHANICAL PROPERTIES**

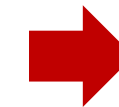


## Optical properties and losses



The **outstanding optical properties** of the present mirrors are linked **to optical losses** in the cavities:

- the optical losses in the cavities increase the signal to noise ratio of the shot noise **degrading thus the detector sensitivity at high frequencies.**
- low losses in the two arm cavities will reduce **the risk of having bad contrast defects** coming from the asymmetry of the two arms.
- the diffused light due to the surface figure error of the mirrors can couple back in the ITF, **adding noise.**



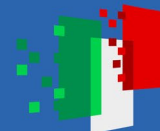
The **round-trip losses** in the arm cavities (fraction of light lost after a round-trip in the cavity) **should be very small** in order to reach a good detector sensitivity.

Flatness	Thickness uniformity	Absorption	Scattering
<0.5 nm RMS (within $\varnothing$ 150 mm)	0.05% (within $\varnothing$ 150 mm)	<0.4 ppm	<10 ppm

The losses in a cavity are due to:

- **diffraction** at low spatial frequency (depending on flatness)
- **scattering** at high spatial frequencies (depending on micro-roughness)
- **absorption** in the coating/substrate
- **punctual defects** on the mirror surface, scratches, digs and points defects.



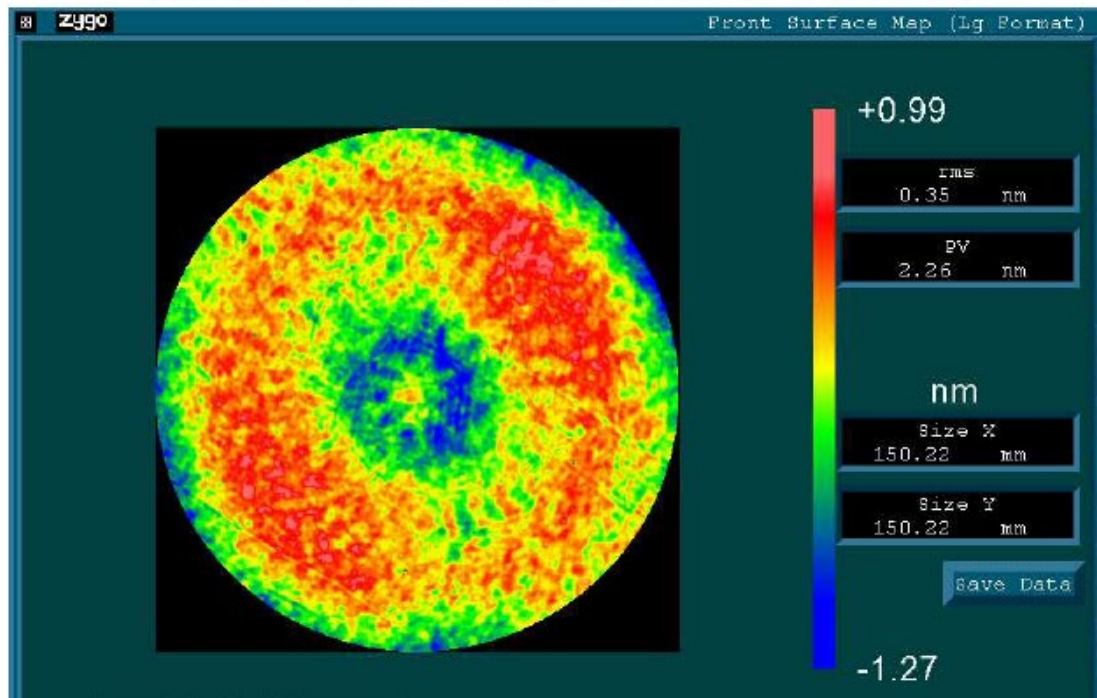


## State of the Art (Virgo/LIGO) – optical properties



**FLATNESS:** Surface Roughness 0.35 nm RMS  $\varnothing$  150 mm

Wavefront Surface 1 (HR), incidence 0° ( $\varnothing$ 150 mm)



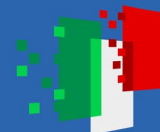
For checking the **level of diffraction at low spatial frequency**

The **surface roughness** is measured to check the flatness of the mirror (low spatial frequency)

The flatness of a mirror surface can be seen as **deviations from an ideal surface**, either plane or spherical depending on the optics

The low surface figure of a substrate is **measured typically with a phase-shifting interferometer**

The parameter commonly used to express the flatness of a surface is the root mean square (RMS) fluctuation in height of the surface.



# State of the Art (Virgo/LIGO) – optical properties



**SCATTERING:** Scattering Surface 4° AOI  $\varnothing$  150 mm

Avg= 6 ppm

Average Scattering Surface 1 (HR), incidence 4° ( $\varnothing$ 150 mm)

Laboratoire des Matériaux Avancés - Villeurbanne - France

C150422B.10R

Wavelength  
= 1.0640  $\mu$ m

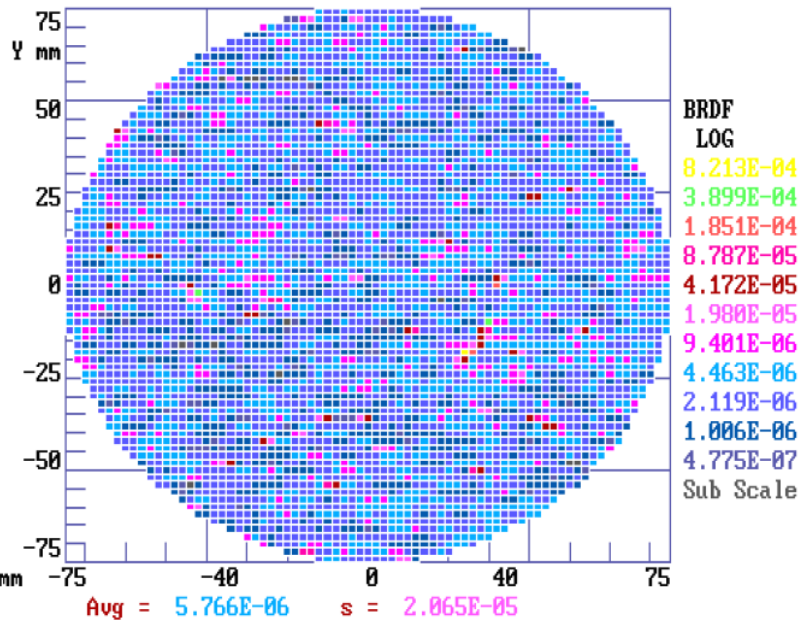
Reflectance  
R = 0.9329

Angles:  
 $\theta_i$  = 4.00°  
 $\theta_s$  = 14.00°  
 $\alpha$  = 0.00°

Spot Dia., mm  
= 2.000

Step Size, mm  
= 2.000

Scan Ctr., mm  
X = 0.000  
Y = 0.000



For checking the **level of diffraction at high spatial frequency**

The *bidirectional reflectance distribution function* (BRDF) is measured at **4° of incidence**

The function takes an incoming light direction,  $w_i$ , and outgoing direction,  $w_r$ , and returns the **ratio of reflected radiance** exiting along  $w_r$  to the **irradiance incident** on the surface from direction:

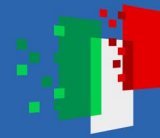
$$f_r(\omega_i, \omega_r) = \frac{dL_r(\omega_r)}{dE_i(\omega_i)} = \frac{dL_r(\omega_r)}{L_i(\omega_i) \cos \vartheta_i d\omega_i}$$

$L$  = radiant flux emitted, reflected, transmitted or received by a given surface, per unit solid angle per unit projected area [W/sr·m<sup>2</sup>]

$E$  = radiant flux received by a surface per unit area [W/m<sup>2</sup>]

$q$  = angle between  $w_i$  and normal surface

Roughness at high spatial frequency is measured with a scatterometer

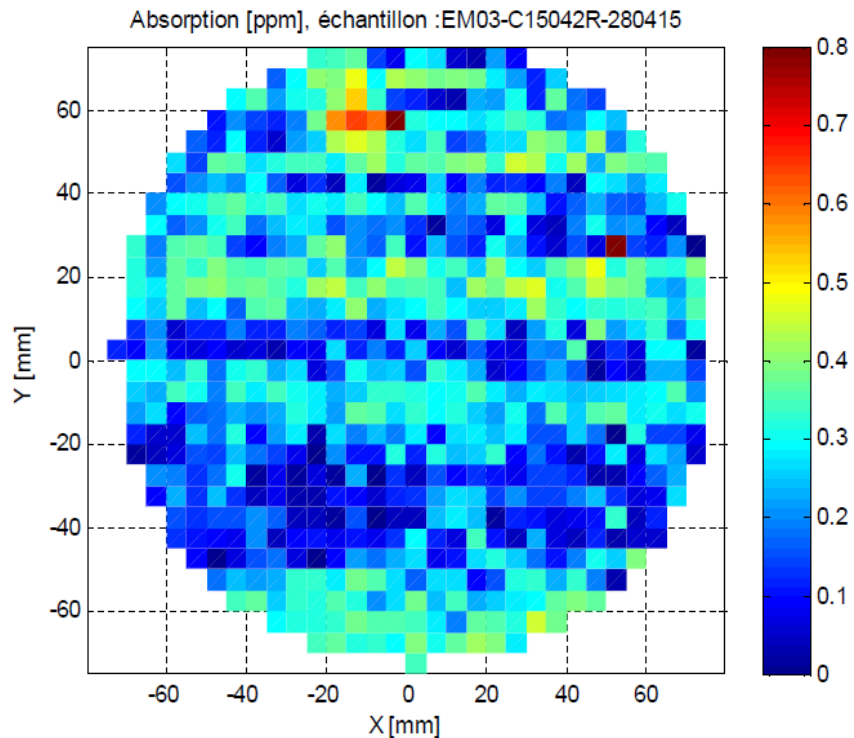


# State of the Art (Virgo/LIGO) – optical properties



## Optical Absorption 0.24 ppm $\varnothing$ 150 mm

Average Absorption Surface 1 (HR)<sup>o</sup> ( $\varnothing$ 150 mm)

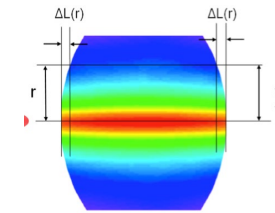


Absorption of optical power in the coating and substrate of the optics is a **dynamical thermal effect**. It needs to be under 1 ppm to avoid **thermal effects**

Lorenzo's talk

- Thermal lensing

$$\Delta OPL_T = \frac{dn}{dT} \int_S \Delta T ds$$



OPL distortions due to **dependence of refractive index from temperature variation**

- Thermo-elastic effect

$$\Delta u \approx \alpha \int_S \Delta T ds$$

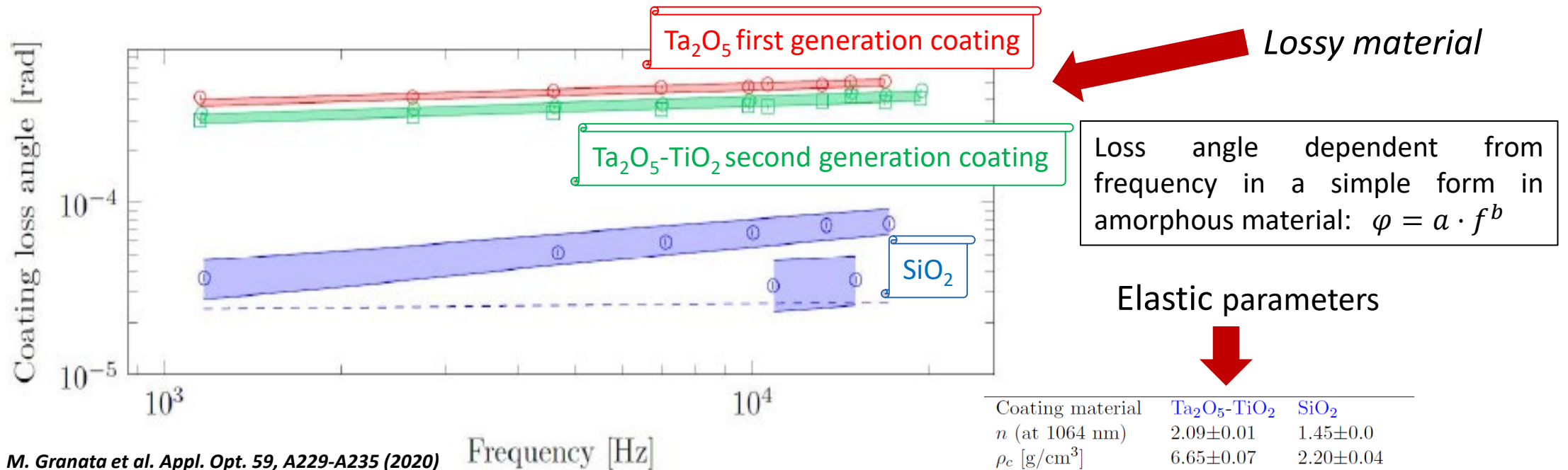


**Change of RoC** of mirrors due to the absorption of laser power

- a system for the compensation of thermal effects is provided



## State of the Art (Virgo/LIGO) – mechanical properties



**How can we measure loss angle of a coating?**

*Metrology of mechanical properties a long way...*

Table 3.2: Optical and mechanical parameter of present coating materials [79]: the loss angle can be extrapolated from  $a$  and  $b$  parameters and is based on the frequency dependence  $\phi_{coat}(f) = a f^b$ .





## Loss Angle

Alex's talk

Essential quantities to characterize the dissipative behaviour of materials:

$$\text{Quality factor } Q \equiv 2\pi \frac{E_{tot}}{E_{diss}}$$

- Systems with high dissipations have low  $Q$  and larger off-resonance contribution, and viceversa

A system is dissipative whenever its *response to a step input* is characterized by a finite relaxation time  $\tau$  → **phase lag**

**between input and response** →  $\text{Loss angle } \varphi(\omega) = \frac{1}{2\pi} \frac{E_{diss}}{E_{tot}}$

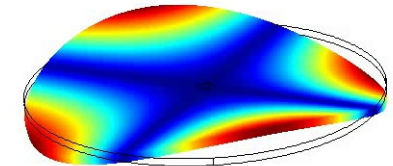
- At resonance  $\varphi(\omega_0) = \frac{1}{Q}$
- Additive quantity

Any physical system can be composed by many different parts (i), whose stored energies (s) can be dissipated by many different mechanisms (m)

- **Dilution factor**  $D_{i,s}(\omega) = \frac{E_{i,s}}{E_{tot}}$
- $\varphi_{tot} = \sum_i \frac{E_{diss,i}}{2\pi E_{tot}} = \sum_i \sum_s D_{i,s}(\omega) \sum_m \varphi_{m,i}^s$



## Metrology of loss angle



### ➤ Resonant ring-down method and Gentle Nodal Suspension

Vibrating body (disc-shaped sample, properly suspended) **damping characteristic time** of free oscillation; the loss angle can be measured looking at the **free decay** of a resonance, and working out the damping rate

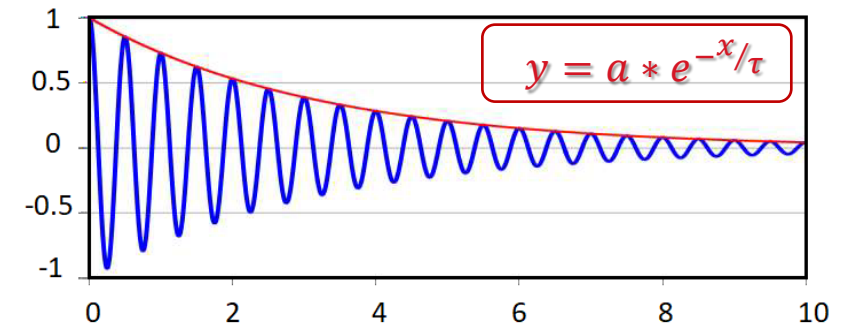
$$\varphi = \frac{1}{\pi f \tau} \rightarrow \varphi_{TOT} = \frac{E_{sub}}{E_{TOT}} \varphi_{sub} + \frac{E_{coat}}{E_{TOT}} \varphi_{coat}$$

### ➤ Coating loss angle detection:

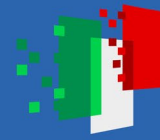
$$\varphi_{coat} = \frac{E_{TOT}}{E_{coat}} \left( \varphi_{TOT} - \frac{E_{sub}}{E_{TOT}} \varphi_{SUB} \right) \cong \frac{E_{sub}}{E_{coat}} (\varphi_{sub+coat} - \varphi_{sub})$$

- ✓ Substrate mechanical characterization **before coating deposition**;
- ✓ **Substrate losses supposed independent of the coating deposition process**;
- ✓ Coated sample mechanical characterization **after coating deposition**;
- ✓ Dilution factor directly evaluable by mode frequency shift measurement before and after coating deposition:

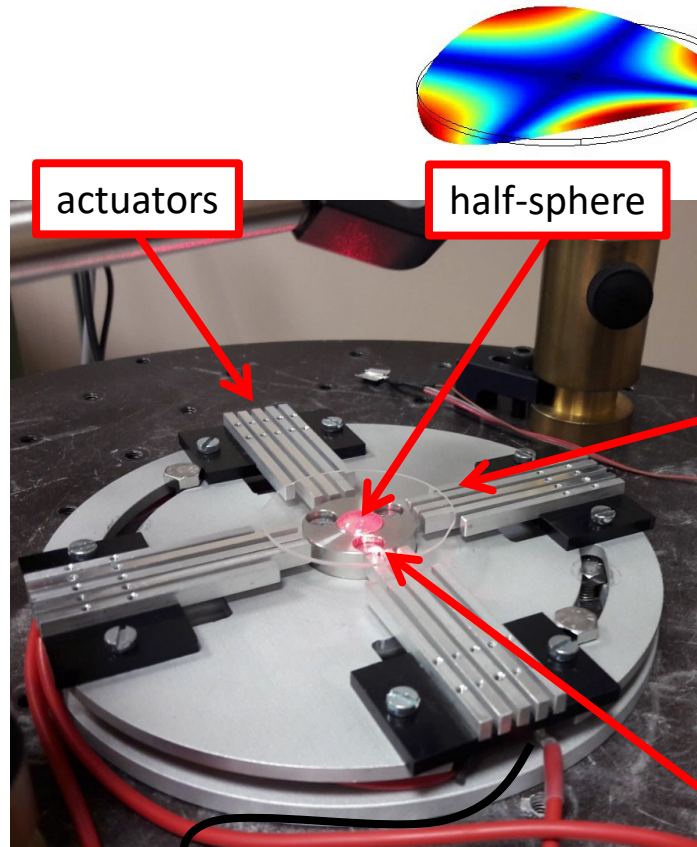
$$D \cong 1 - \left( \frac{f_0}{f} \right)^2 \frac{m_0}{m} \cong \frac{3Y_{coat} t_{coat}}{Y_{sub} t_{sub}}$$



- **Stability of the substrate's losses and resonant frequencies is mandatory**
- **Spurious frequency shifts need to be avoided or controlled and subtracted**



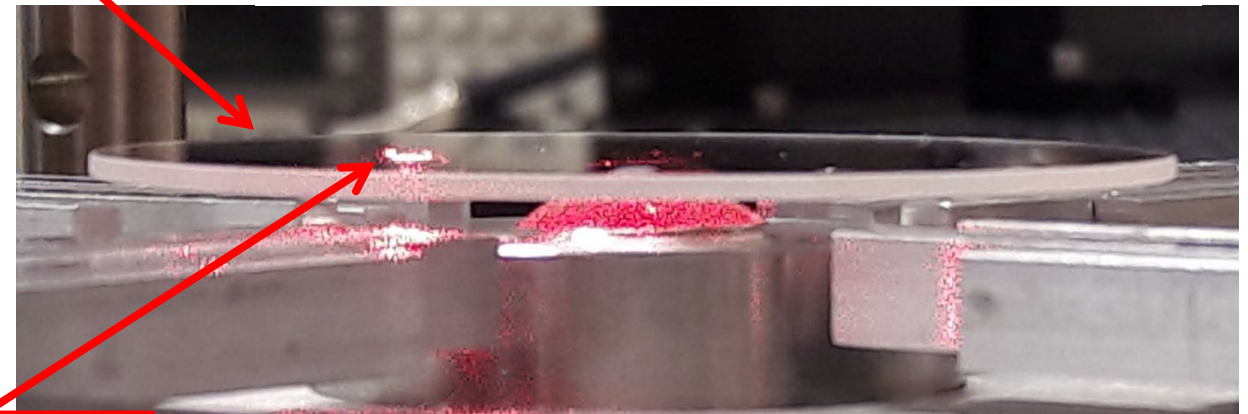
# GeNS – schematic view



Electrostatic actuation

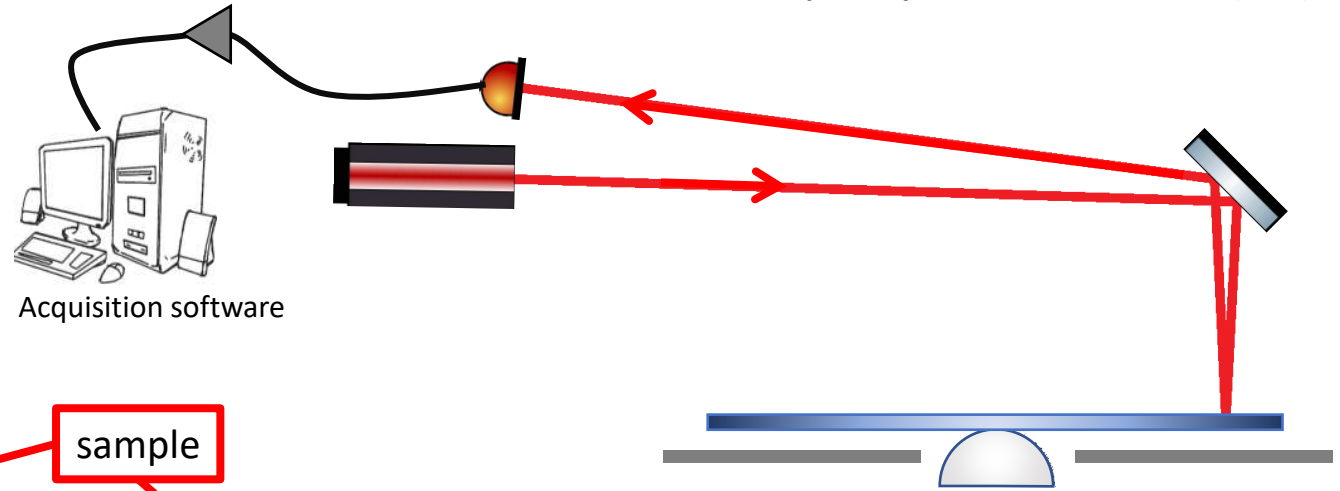


sample



optical lever spot

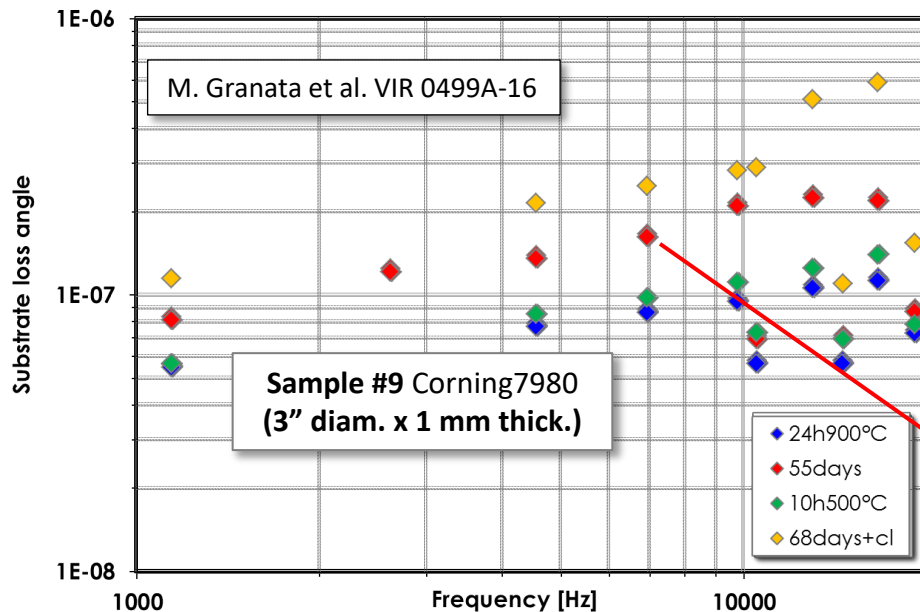
E. Cesarini et al. Review of Scientific Instruments 80, 053904 (2009)





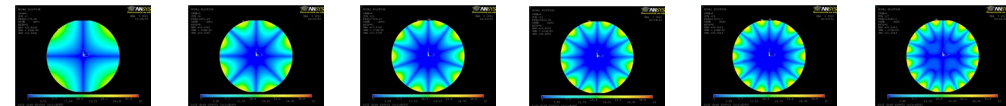
# Metrology issues – substrate stability

To enhance substrate mechanical quality and its stability a **specific thermal treatment** is used (annealing)

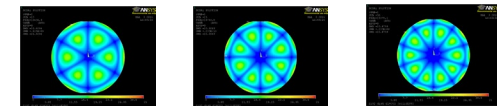


➤ Shape dependence → **family modes**

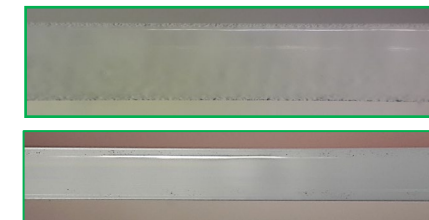
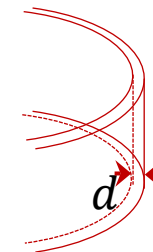
- Butterfly modes, azimuthal nodal lines



- Mixed modes, azimuthal and radial nodal lines



➤ Time dependence → **ageing**

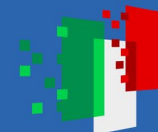


D. Lumaca et al. Journal of Alloys and Compounds, Volume 930, Issue 5, 2023

G. Cagnoli et al. Physics Letters A, Volume 382, Issue 33, 2018,

➤ Surface losses  $\varphi_{TOT} = D_{disc} \varphi_{disc} + D_{barr} \varphi_{barr} = Af^B + d\varepsilon\varphi_{barr}$





## Metrology issues – frequency shift monitoring



To have a good estimation of the coating loss angle  $\phi_{coat}$ , we need a full characterization of the substrate before any treatment and a **monitoring of resonance frequencies**. The dilution factor **D**, in fact, is **frequency dependent** and we are assuming that **any possible frequency and mass variations are attributable only to coating deposition**.

$$\varphi_{coat} = \frac{1}{D} [\varphi_{sub+coat} - (1 - D)\varphi_{sub}]$$

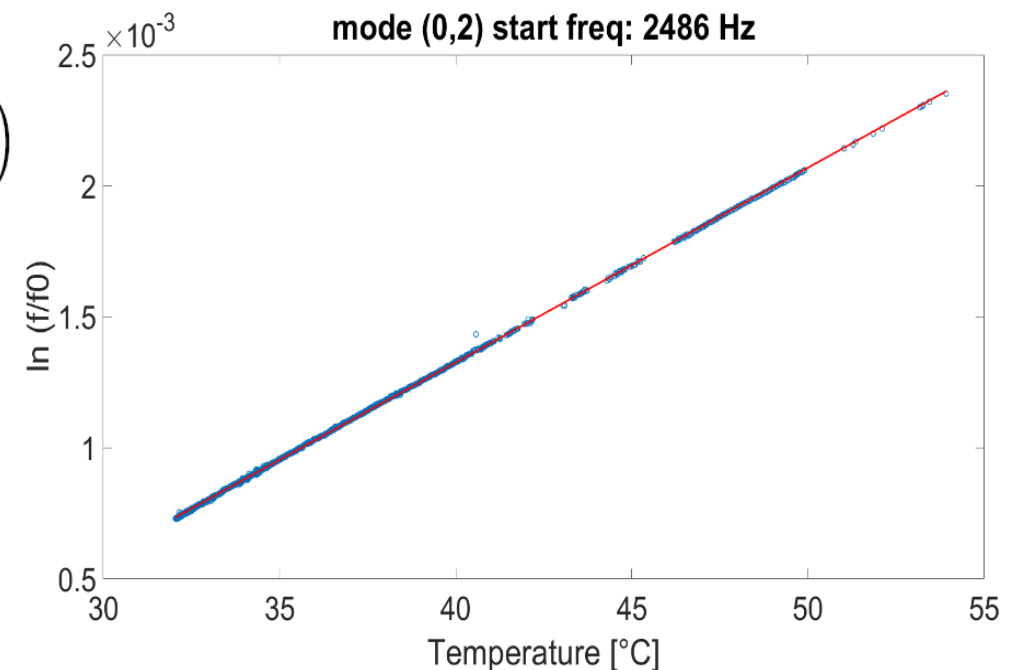
$$D = 1 - \left( \frac{f_{sub}}{f_{sub+coat}} \right)^2 \left( \frac{m_{sub}}{m_{sub+coat}} \right)$$

### TEMPERATURE

Different temperature condition can determine systematics on dilution factor measurement by frequency shifts



- Temperature witness sample
- Temperature correction to measured frequencies





## Metrology issues – frequency shift monitoring

To have a good estimation of the coating loss angle  $\phi_{coat}$ , we need a full characterization of the substrate before any treatment and a **monitoring of resonance frequencies**. The dilution factor **D**, in fact, is **frequency dependent** and we are assuming that **any possible frequency and mass variations are attributable only to coating deposition**.

$$\varphi_{coat} = \frac{1}{D} [\varphi_{sub+coat} - (1 - D)\varphi_{sub}]$$

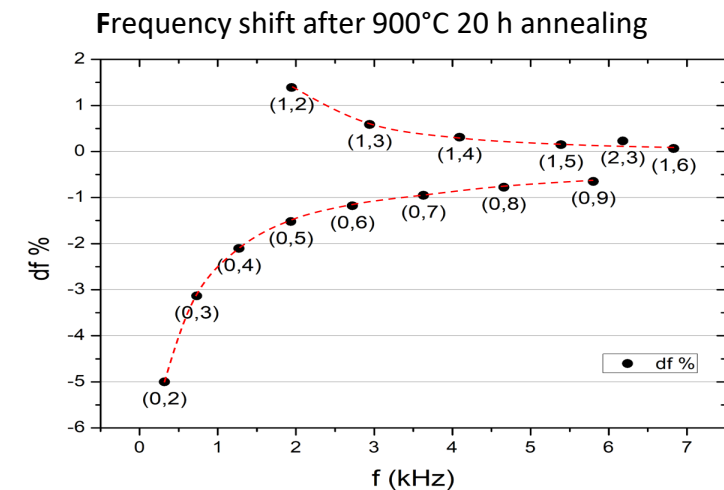
$$D = 1 - \left( \frac{f_{sub}}{f_{sub+coat}} \right)^2 \left( \frac{m_{sub}}{m_{sub+coat}} \right)$$

### SUBSTRATE ANNEALING

A substrate thermal treatment produces frequency shift. Typical temperature of 900 °C does not make the substrate stable: frequencies are changed by further annealings.



- Frequency shifts are **not related to geometrical deformation** but to a **variation of elastic properties** (Poisson coefficient)
- Annealing at 1000 °C is a better choice (small frequency shift, sample stability)





## Metrology issues – coating losses modelling

- Separating the **contributions** of different elastic strains, different loss mechanisms
- Focusing on structurally **isotropic coatings**. When they grow amorphous, this does not usually induce a significant structural anisotropy.
- Assuming the **elastic response** fully captured by just two elastic constants and the film loss given by the two related contributions associated with either **bulk or shear strains**

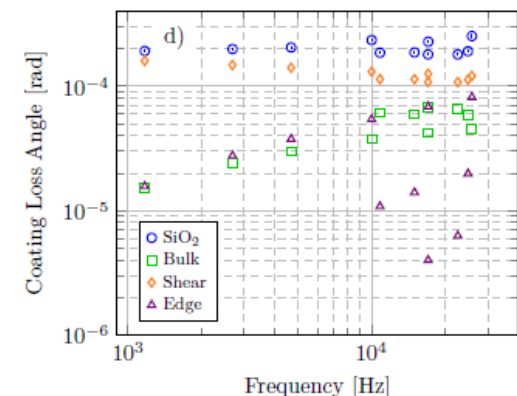
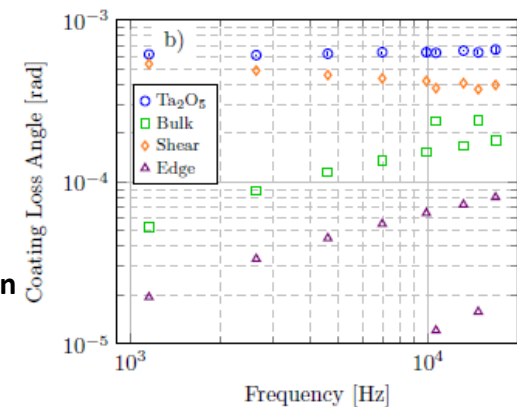
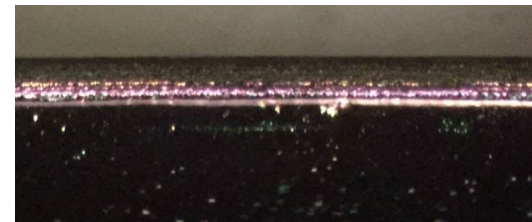
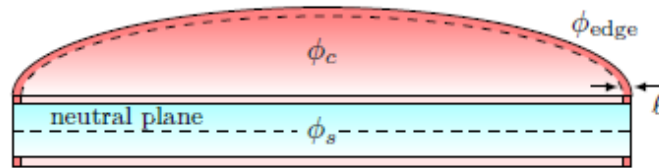
$$\phi_c = D_{\text{bulk}} A_1 f^{\alpha_1} + D_{\text{shear}} A_2 f^{\alpha_2}, \quad \begin{cases} \bullet \text{ Bulk strain is related to volume change} \\ \bullet \text{ Shear strain is related to parallel deformation} \end{cases}$$

BUT, an **excess edge losses may arise** from a variety of reasons such as, coating **thickness non-uniformity** at the edge, coating **spill-off** during the deposition, **tapering/shading** due to the sample holder during deposition, or coating deposition on an unpolished surface and an associated **lack of adhesion** near the edge.

$$\phi_c = \left( D_{\text{bulk}} - \frac{\ell}{R} \varepsilon_{\text{bulk}}^{\text{edge}} \right) \phi_{\text{bulk}} + \left( D_{\text{shear}} - \frac{\ell}{R} \varepsilon_{\text{shear}}^{\text{edge}} \right) \phi_{\text{shear}}$$

$$D_{\text{bulk}}^{\text{edge}} = \frac{\ell}{R} \varepsilon_{\text{bulk}}$$

$$D_{\text{shear}}^{\text{edge}} = \frac{\ell}{R} \varepsilon_{\text{shear}}$$



A. Amato et al. Phys. Rev. D **106**, 082007, 2022

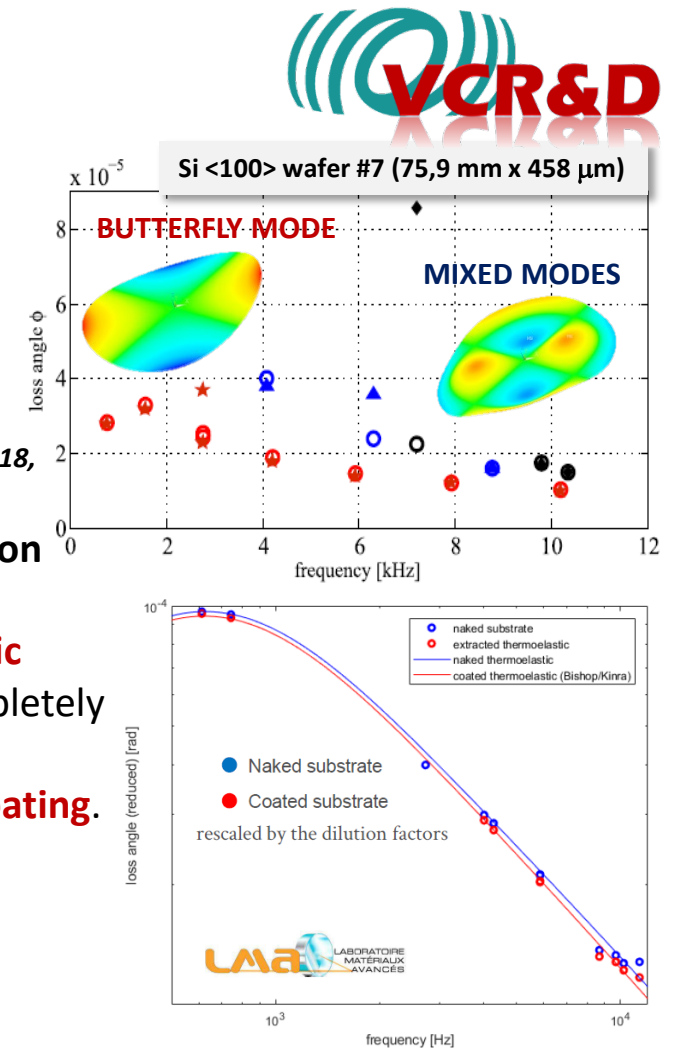


## Metrology at low T

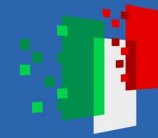
- Future GW detectors are proposed to be operated at **cryogenic temperatures**
- The knowledge of **mechanical properties** at **low temperatures** is strongly required to predict their thermal noise limited sensitivity
- Cryogenic loss angle measurements are necessary to understand the **loss mechanism** in the more general physics of amorphous materials

*G. Cagnoli et al. Physics Letters A, Volume 382, Issue 33, 2018,*

- **Crystalline substrates** need to be used to be characterized at all T, due to a **high dissipation peak of amorphous SiO<sub>2</sub> at low T**.
- But **crystalline materials** such as silicon and sapphire are dominated by **thermoelastic dissipation** especially at room temperature. This dissipation mechanism can be completely modelled in disk shaped samples
- The **thermoelastic dissipation of the substrate is changed by the presence of the coating**. We have **models** for computing coated samples thermoelastic losses, but **thermo-mechanical parameters are generally poorly known**
- Innovative strategies need to be identified: i.e. **use different geometry** to excite longitudinal modes that do not suffer of thermoelastic.





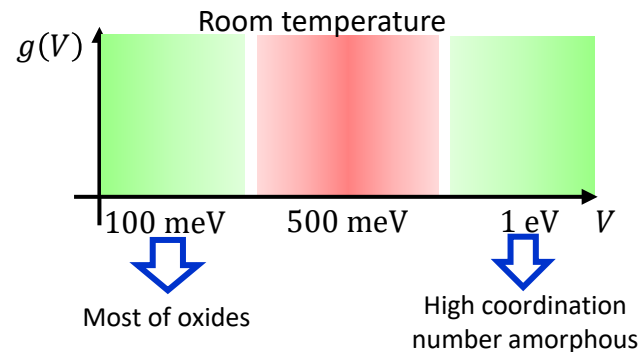


## Material Research – Amorphous Material – TLS

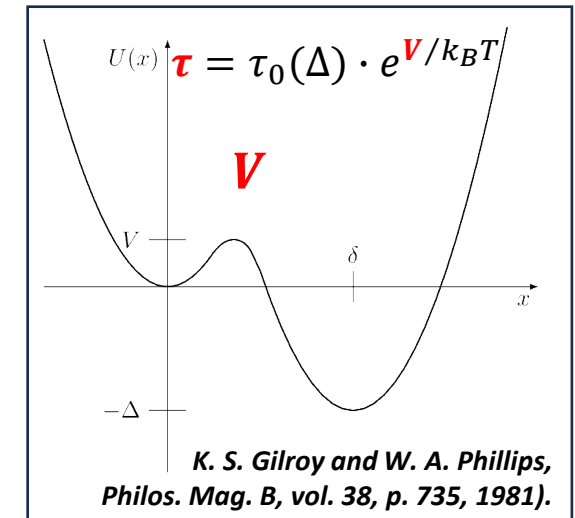
- The anelastic behaviour of amorphous materials is explained by the presence of a number of **metastable states**. Any two of these states that are **separated by an energy barrier** is called a Two-Level System (TLS).
- The lifetime  $\tau$  and the loss angle  $\phi$ , at acoustic frequency  $\omega$ , resulting from a density  $N$  of such double wells of barrier height  $V$  and asymmetry  $\Delta$  is given by:

$$\phi = N \frac{\gamma^2}{Yk_B T} \frac{\omega \tau}{1 + \omega^2 \tau^2} \operatorname{sech}^2 \left( \frac{\Delta}{k_B T} \right)$$

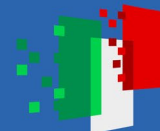
- The **number density of TLS** can vary a lot from material to material or even within the same material depending on the production technique or treatments used.



The ones that are **active** are only those that have a **relaxation time comparable to the period of the strain wave propagating in the material**.



In the case of GW detection, the frequency band of interest gives a period  $\sim 10^{-3}$  s. Considering that the temperature dependence of the relaxation time follows an Arrhenius' law and that the fundamental time constant is  $t_0 \sim 10^{-13}$  s then the TLS that contribute to the mechanical losses at room temperature are those that have a barrier height of **0.5 eV**.



# Material research – High Coordination Number materials

In order to reduce the loss angle of amorphous materials a **reduction of the total number density of TLS** can be pursued

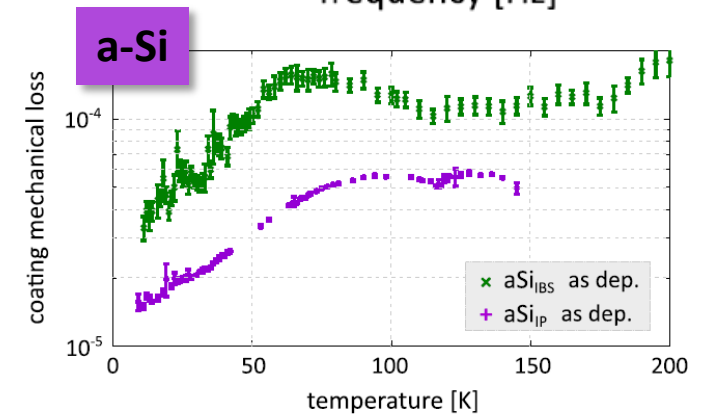
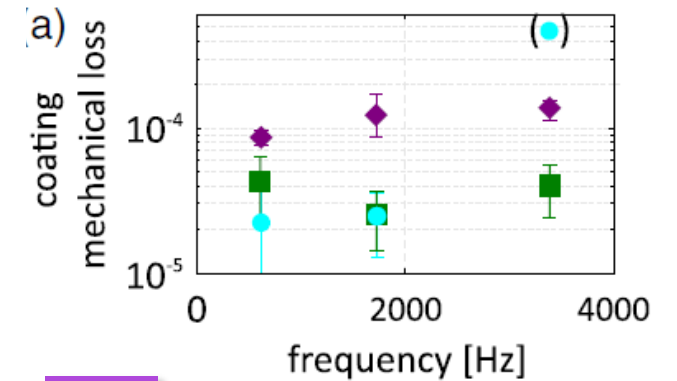
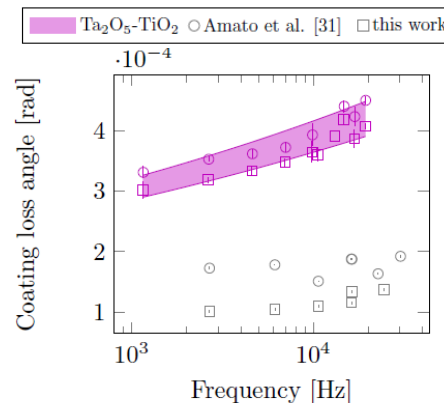
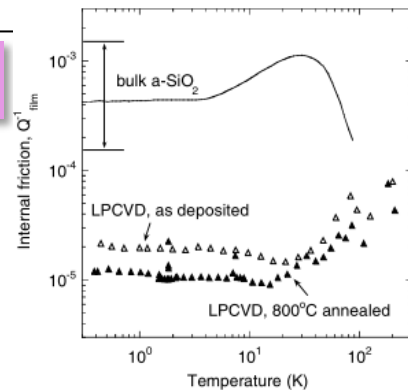
Depositing amorphous films whose **coordination number** of their constitutive atoms are superior to 3, the **structure** is more **rigid** and **TLS are unlikely**.

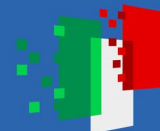
The structural units of these **high number coordination materials** are often linked via their edges or their faces making structural reorganization more difficult.

### Frozen structure materials = Low TLS density

- Nitrides (SiN, GaN)
- Carbides (SiC)
- Amorphous semiconductor (aSi, GaAs, GaP, InP, CdTe, AISb,...)

SiN





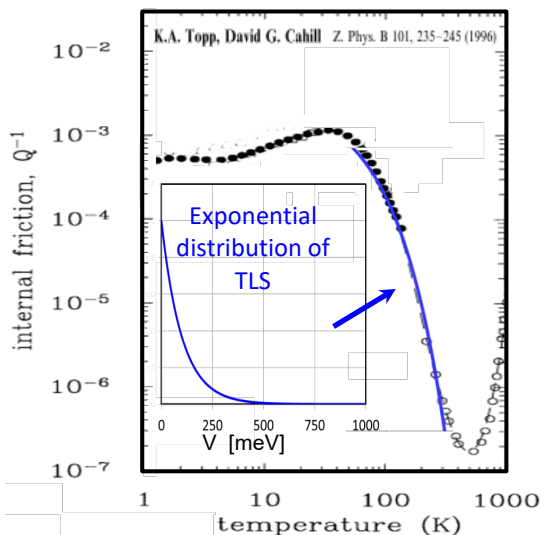
# Material research – deposition and post deposition

In order to reduce the loss angle of amorphous materials another basic ideas is to provide a **wise/optimal TLS distribution**

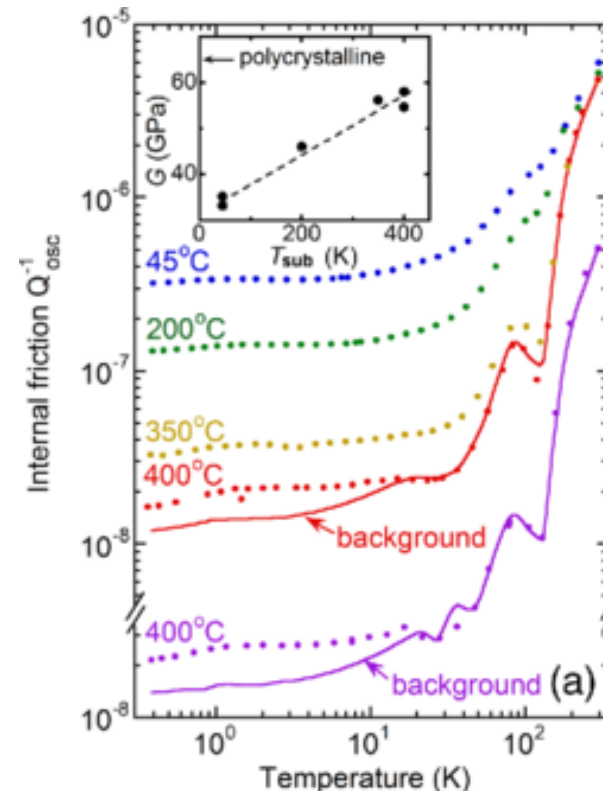
**Floppy structure materials = Wise TLS distribution**

- Post Deposition Annealing (SiO<sub>2</sub>)
- High Temperature Deposition (a-Si)

F. Travasso et al. Europhys. Lett., vol. 80, 2007.

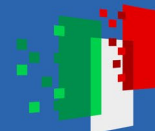


The **annealing** is believed to **change the distribution of the TLS**, reducing those with higher barrier and **increasing the small ones**. Deposited SiO<sub>2</sub> shows a *significant reduction of losses* from an increase of annealing temperature and duration.



It is believed that the **increased mobility** obtained through the **high temperature** makes the amorphous materials **exploring the configurational space at an extremely fast rate** so that statistically it reaches a **minimum energy state** that has a low density of TLS.

X.Liu PRL 113, 025503 (2014)



# Origin of Absorption

## ➤ Level of absorption and its origin

### Material Choice

- **Energy bandgap** need to be **high enough to be transparent** at the used wavelength
- **Refractive index** need to be **high enough to guarantee a high optical contrast** and small thickness of layers

### Optical Absorption origin

- There is not yet a well-established model
- **Target** values for each material are given by the **crystalline form**
- Amorphous structure produces **localized states in the band gap**
- The bandgap needs to be clean of electronic states

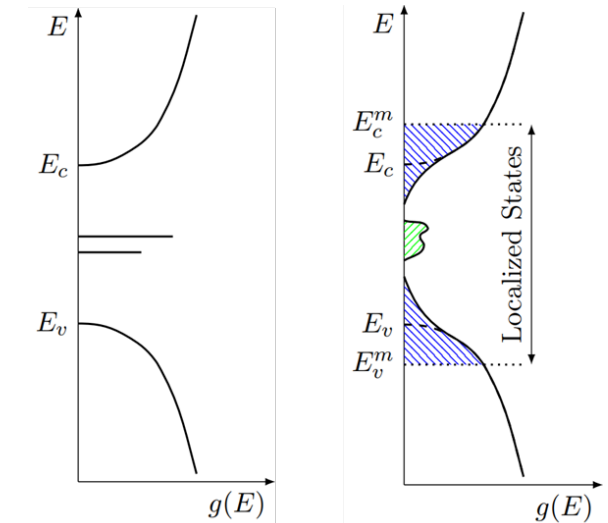
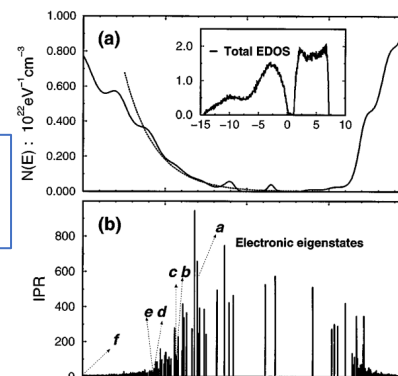
### Possibles causes of absorption

- Wrong **stoichiometry**
- Presence of **contaminants**
- Presence of **structural defects**

### Possibles solutions

- Improve the **deposition technology**
- Maximize the **coordination number**
  - Through HT deposition
  - Through annealing and controlled crystallization

Hanna's talk



Crystals

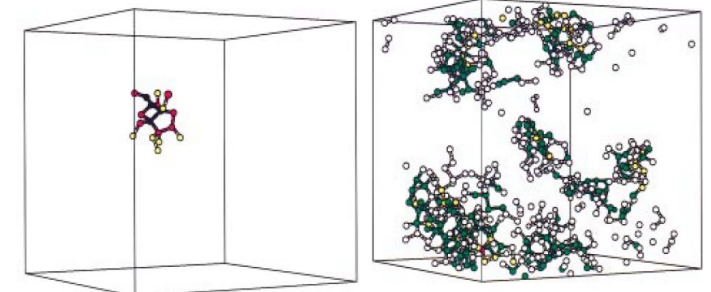
Amorphous

### Atomistic Structure of Band-Tail States in Amorphous Silicon

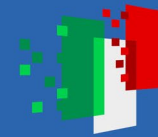
Jianjun Dong and D. A. Drabold

(a)  $E = 0.1974$  eV; IPR = 658

(d)  $E = -0.0542$  eV; IPR = 24







## Multi-technique investigation

- The absorption in thin films is determined by an **interplay of several factors** (stoichiometry; contaminants; films homogeneity; ...)
- The **investigation** of the origin of absorption **involves (at least) three domains**

### Optical properties

Quantity	Technique
n	Spectrophotom. Ellipsometry
k	Spectrophotom. Phototherm. defl. Ellipsometry
gradient	Spectrophotom. Ellipsometry

### Chemical/compositional properties

Quantity	Technique
Stoichiometry, H content, O content, Contaminants	EDX
	XPS
	"
	Raman
	FTIR
	RBS
	SIMS
	ERDA
	RBS

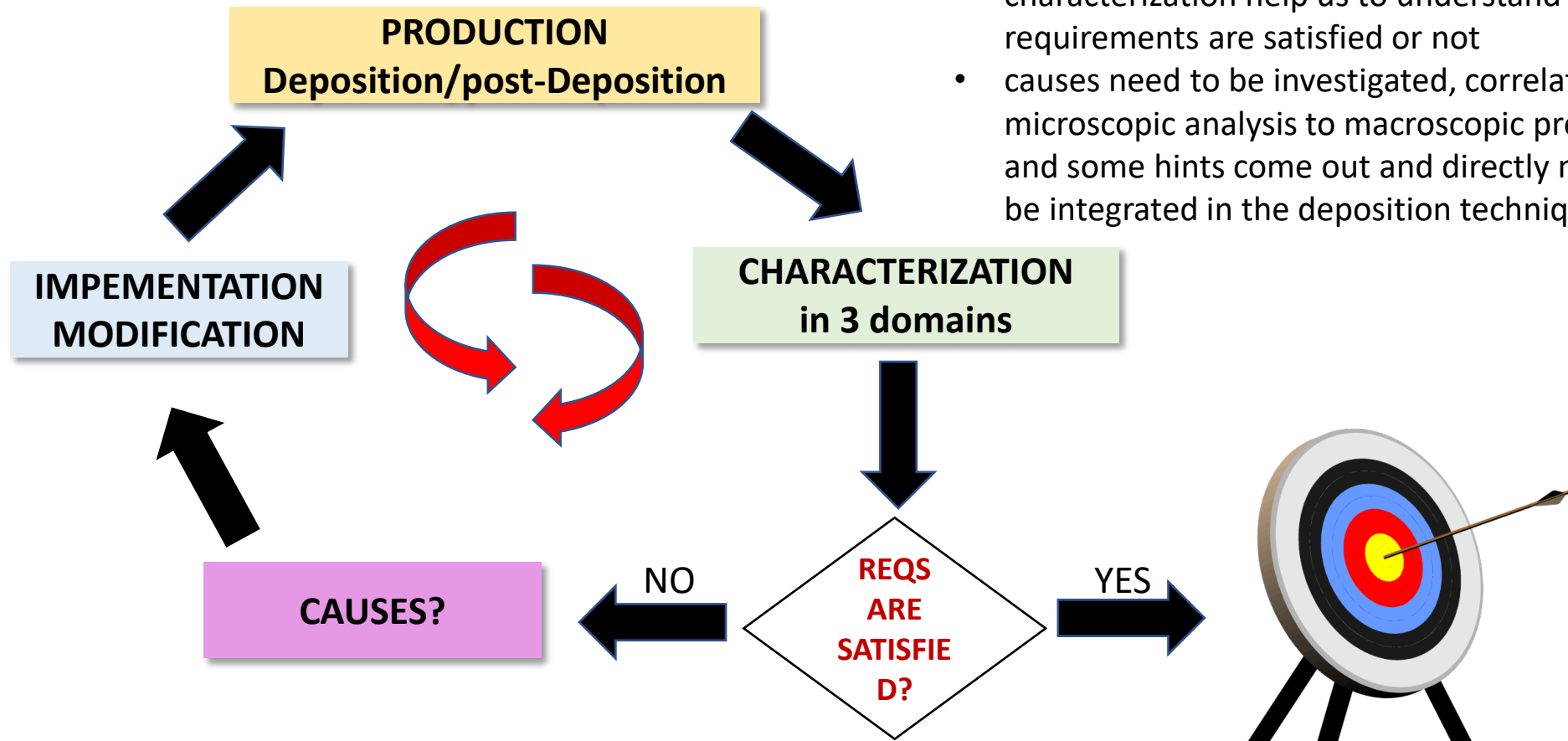
### Morphological/structural properties

Quantity	Technique
Thickness	Spectroph. Ellipsom.
Surface analysis	SEM AFM

Long list but not completed of set up with different characterization method that are commonly used.

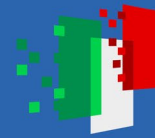


# Optimization Loop



Loop for the optimization of deposition process:

- production
- characterization help us to understand if the requirements are satisfied or not
- causes need to be investigated, correlating microscopic analysis to macroscopic properties and some hints come out and directly need to be integrated in the deposition technique



## Possible coating materials under investigation

### ➤ Oxides

➤ **HCNG** – Nitrides (SiN, GaN), Semiconductors (a-Si) –: high coordination number makes atom structure more rigid decreasing TLS density low loss dissipation

➤ **Multi-material Coating or ternary coatings**: multi-material coatings, in which the **top layers**, where the optical intensity is highest, consist of materials with **low optical absorption** but too large mechanical loss, while the **lower layers** consist of materials with **low mechanical loss** but too large optical absorption

➤ *Coating structure and design*

➤ **Crystalline Coating** – Semiconductor or Oxides –: **epitaxially grown** coatings consisting of alternating layers of **high and low index layers of crystalline materials** present an alternative method that avoids the mechanical loss issues associated with TLS in amorphous materials.



# Crystalline coatings basics

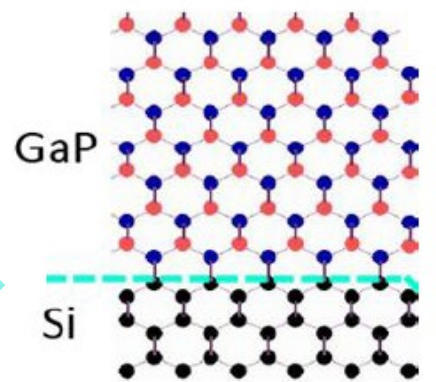
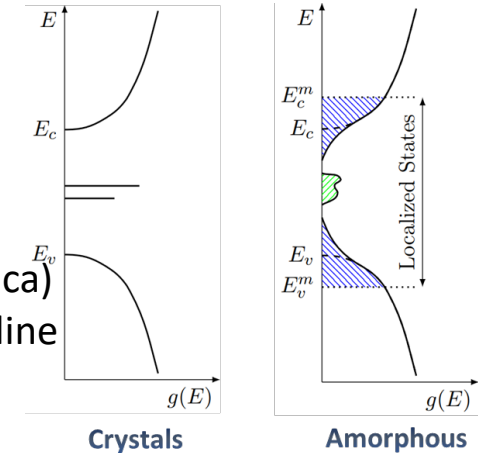
## Many crystalline materials show very favorable properties:

- **Smaller or more narrow loss peak** at low temperature (i.e., crystalline quartz vs. amorphous silica)
- **Lower IR optical absorption**, maybe due to lack of electronic states in the band gap (i.e., crystalline silicon vs. amorphous silicon @2 um)

## Single-crystalline multilayers:

Hanna's talk

- Deposited by **MBE** (Molecular Beam Epitaxy)
  - takes place in ultra-high vacuum ( $10^{-8}$ – $10^{-12}$  Torr); deposition rate is typically less than 3,000 nm per hour, that allows the films to grow epitaxially
  - crystal growth in which new crystalline layers are formed with one or more **well-defined orientations** with respect to the **crystalline seed layer**
- requires **two lattice matched materials and lattice matched substrate**
  - Limited options for **high/low refractive index combinations**
  - Limited options for **substrate materials** to grow on

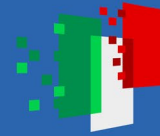


Size restricted due to maximum substrate size

Substrate transfer (bonding) possible, if not directly grown on test mass

additional advantage: 'upside-down' bonding can bring 'good' layers to top (where intensity is high)





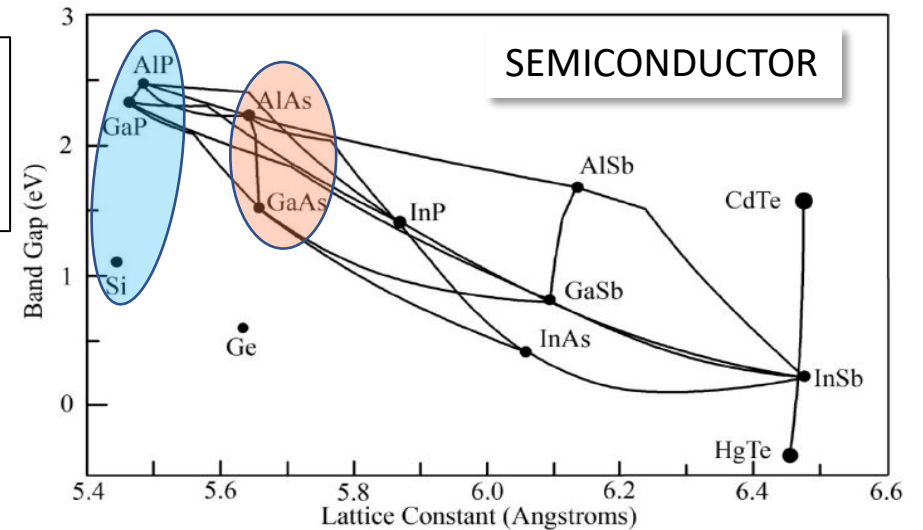
## AlGaAs/GaAs

LSC groups looking into:

- AlGaAs/GaAs on GaAs
- GaP/AlGaP on Si

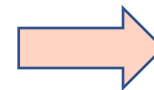
Advantages:

- Same/similar lattice constant
- Different band gap
- Dopants help matching the lattice constant, but reduce the bandgap/refractive index contrast



**GaAs/AlGaAs** coating grown on **GaAs wafers** bonded to fused silica or silicon

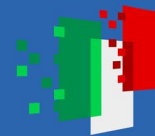
- ✓ Refractive index:  $\approx 3.5$  for GaAs and  $\approx 3.0$  for AlGaAs @1064nm
- ✓ Promising results for thermal noise
- ✓ Low optical absorption



Requires more, but thinner layers than SiO<sub>2</sub>/Ta<sub>2</sub>O<sub>5</sub>

- $\sim 10$  x below SiO<sub>2</sub>/Ta<sub>2</sub>O<sub>5</sub> in PSD
- even better at 10K

- $\sim 1$ ppm at 1064nm
- Few ppm at 1550nm



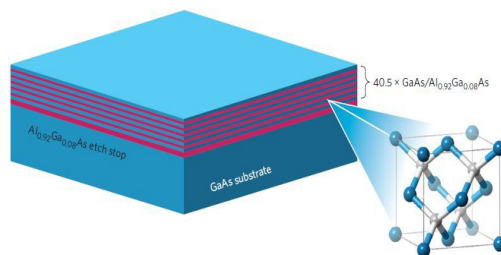
## AlGaAs/GaAs

### AlGaAs/GaAs on GaAs wafer at LSC

- **Well established** technology only for **small sizes**
- Size restrictions: GaAs wafers only available in sizes up to 200 mm
- At cryo T a **good bond quality is required** due to thermal expansion during cooling cycles (in the past, coating dissolved from substrate after several cooling cycles)

#### ONGOING ACTIVITIES

- **Birefringence** measurements
- Investigations of Pockels effect in AlGaAs (electro-optic noise, e.g., light-field induced birefringence)

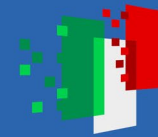


limitation for AlGaAs/GaAs coating size



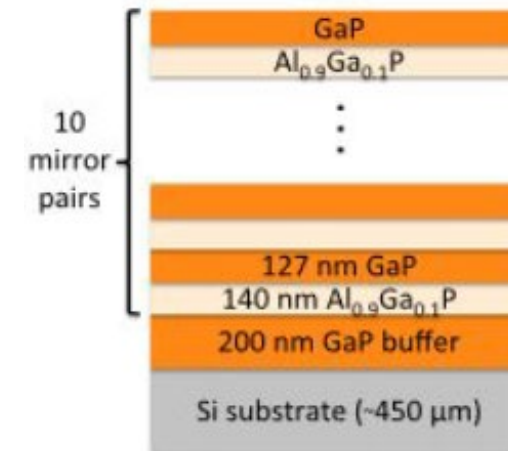
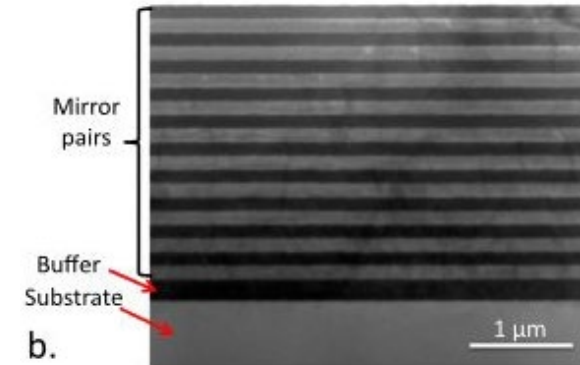
- Enough thermal-noise benefit to use slightly smaller coatings
- Upscaling to  $\approx 30\text{cm}$  mainly a cost question (Uniformity at 300 mm?)

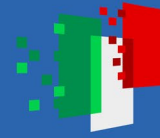
GaAs size, large-scale bonding, bonding on silicon for cryogenics operation are the main issues



## AlGaP/GaP

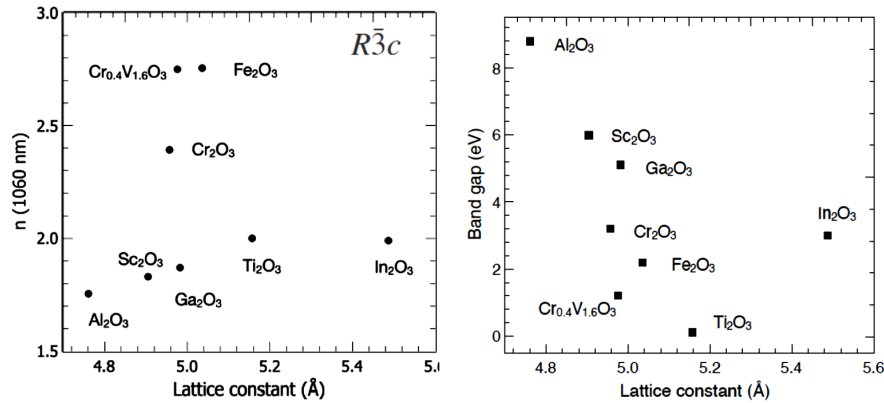
- ✓ AlGaP/GaP coatings **grown on Si wafers** - in principle possible **without bonding/substrate transfer**
  - Considered for **cryogenics**
  - MBE process slow due to **health and safety issues** etc.
- ✓ Refractive index:  $\approx 3.05$  for GaP and  $\approx 2.77$  for AlGaP at 1550nm
- ✓ **Promising results for mechanical loss** at low temperature
  - $< 3 \times 10^{-5}$  for a **GaP single layer** with 'bridge' layer to match silicon lattice at 20K,
  - $1.4 \times 10^{-5}$  for an AlGaP/GaP multilayer at 12 K (comparable to SiO<sub>2</sub>/Ta<sub>2</sub>O<sub>5</sub> at room temperature)
- ✓ Optical **absorption** initially **rather high** (likely due to impurities)
  - $\approx 2.3\%$  at 1550nm





# Crystalline Oxides

- Bandgap and refractive index



➤ Can be **grow on sapphire**, that has no limitation in dimension of wafer and that has potentially high optical contrast to guarantee thinner multi-layer stack

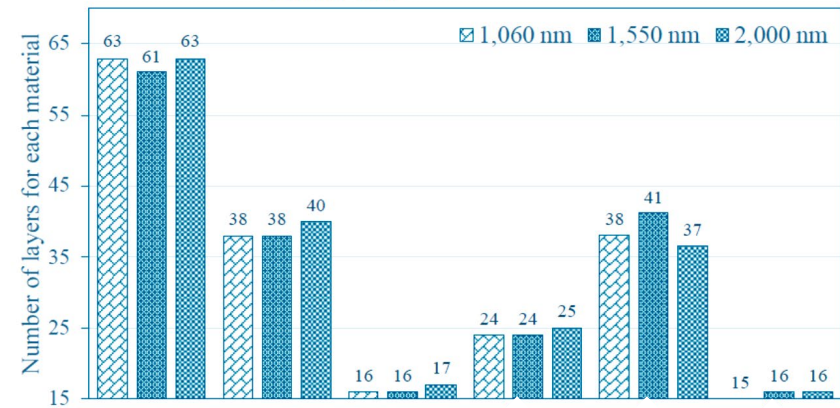
# Bilayer pairs

$$R_{2N} = \left[ \frac{\left( n_s \left( \frac{n_H}{n_L} \right)^{2N} - n_0 \right)}{\left( n_s \left( \frac{n_H}{n_L} \right)^{2N} + n_0 \right)} \right]^2$$

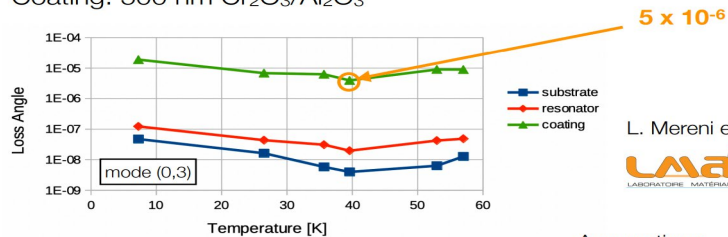
KU LEUVEN

- For R = 99,999% on Si

Gaurav Vats



- Coating: 500 nm Cr<sub>2</sub>O<sub>3</sub>/Al<sub>2</sub>O<sub>3</sub>



L. Mereni et al.  
LMA  
LABORATOIRE MATERIAUX AVANCEES

- Dilution factor = 0.0034  
=  $3 (d_{\text{coating}}/d_{\text{substrate}})(Y_{\text{coating}}/Y_{\text{substrate}})$

Assumptions:  
 $d_{\text{coating}} = 500 \text{ nm}$   
 $d_{\text{substrate}} = 0.3 \text{ mm}$   
 $Y_{\text{coating}} = 260 \text{ GPa}$   
 $Y_{\text{substrate}} = 385 \text{ GPa}$

7

Crystalline Oxides

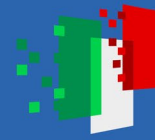




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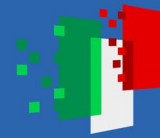
Thank you for your time and attention!



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DI RIPRESA E RESILIENZA

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# Development of materials for ultra-low loss optical coatings

## GOAL:

increase the mechanical performances of today's reflective coatings, retaining their outstanding optical and morphological properties

### ***Candidate materials***

Trial and error approach VS systematic approach

- deeper understanding of the **underlying physical mechanisms driving the losses**

### ***Amorphous materials***

Overall disordered structure, locally arranged.

*Dissipative mechanism*

- Two Level System (TLS): metastable states separated by an energy barrier

➤ Floppy (optimal distribution of TLS) materials

- TiO<sub>2</sub>:GeO<sub>2</sub>, TiO<sub>2</sub>:SiO<sub>2</sub>

➤ Stiff (reduced number of TLS) materials

- SiN, aSi

### ***Crystalline coatings***

Band gap free of localized states, dissipative mechanisms are limited

- ❖ transfer and maximum available size; development costs are currently a major limitation

- GaAs/AlGaAs, crystalline coatings

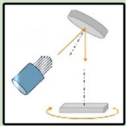




# Development of materials for ultra-low loss optical coatings

## GOAL:

increase the mechanical performances of today's reflective coatings, retaining their outstanding optical and morphological properties



### *Different deposition methods and fine-tuning deposition parameters*

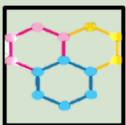
- Ion Beam Sputtering (IBS)
- Magnetron Sputtering (MS)
- Chemical Vapor Deposition (CVD)
- Molecular-beam epitaxy (MBE)



### *Post-deposition treatments*

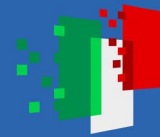
#### Annealing

- improve the **atomic organization** of the coating in the medium-range order and reduce its mechanical loss angle
- modify the **chemical composition** (desorption of contaminants)
- **controlled crystallization**



### *Mixing*

- **Enhances material properties** (like refractive index and mechanical losses)
- **Prevents crystallization**, allowing for higher annealing temperatures.
- **Reduces stress**
- ❖ Introduces an **additional variable** that must be precisely managed during fabrication

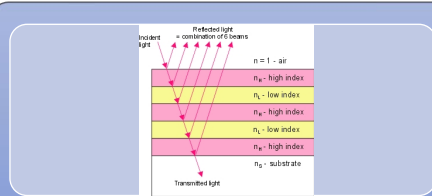


# Development of materials for ultra-low loss optical coatings

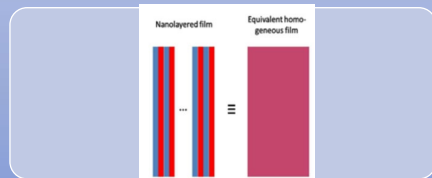
GOAL:

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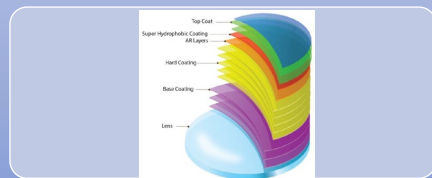
Coating structure and design



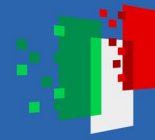
**Bragg reflectors**: thickness optimization, to maintain the desired reflectivity and reduce coating thermal noise (CTN)



**Nano-layering**: periodic stack of ultrathin (nanometer-scale) films that behaves like a homogeneous material with a tunable refractive index. It can be annealed at higher temperatures, thanks to geometrical suppression of crystallization



**Multimaterial approach**: Combination of different materials with low optical absorption near the surface and minimized mechanical losses deeper within



# Development of materials for ultra-low loss optical coatings

## GOAL:

increase the mechanical performances of today's reflective coatings, retaining their outstanding optical and morphological properties

***Candidate materials***

***Coating deposition techniques  
and treatments***

***Coating structure and design***

## ***Investigation techniques:***

- ***Optical properties:*** measurement of optical absorption and/or extinction coefficient and refractive index (spectroscopic ellipsometry)
- ***Mechanical dissipation properties:*** measurement of loss angle and substrate preparation procedure (thermal annealing and polishing of barrel), density and elastic constants (Brillouin spectroscopy); numerical simulations (molecular dynamics, FEA)
- ***Microscopic structure:*** chemical composition and stoichiometry (XPS), crystallization (XRD, Raman spectroscopy); local molecular structures (Raman sp.); topology and surface composition (AFM and SEM)
- ***Thermal and opto-thermal properties:*** optical path as a function of temperature (thermo-refractive measurement); measurement of the coefficient of linear thermal expansion (Curvature measurement)

➤ ***Comprehensive picture of the relevant physics of a given material***